

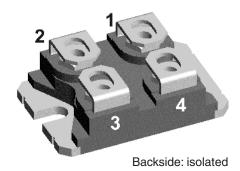
# SiC Schottky Diode

prelimininary

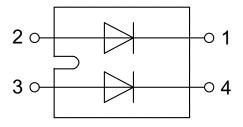
 $V_{RRM} = 1200 V$  $I_{FAV} = 2x 25 A$ 

## Ultra fast switching Zero reverse recovery

Part number **DCG45X1200NA** 



**UL** pending



#### Features / Advantages:

- · Ultra fast switching
- Zero reverse recovery
- Zero forward recovery
- Temperature independent switching behavior
- Positive temperature coefficient of forward voltage
- $\bullet T_{VJM} = 175^{\circ}C$

#### **Applications:**

- Solar inverter
- Uninterruptible power supply (UPS)
- Welding equipment
- Switched-mode power supplies
- Medical equipment
- High speed rectifier

Package: SOT-227B (minibloc)

- Isolation Voltage: 3000 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Base plate with Aluminium nitride isolation for low thermal resistance
- Advanced power cycling

#### Terms & Conditions of Usage

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact the sales office, which is responsible for you. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you. Should you intend to use the product in aviation, in health or live endangering or life support applications, please notify. For any such application we urgently recommend

- to perform joint risk and quality assessments;
- the conclusion of quality agreements;
   to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, test conditions and dimensions.

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SiC Diode (per leg)			Ratings			
Symbol	Definitions	Conditions	min.	typ.	max.	
V <sub>RSM</sub>	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^{\circ}C$			1200	V
V <sub>RRM</sub>	max. repetitive reverse blocking voltage	$T_{VJ} = 25^{\circ}C$			1200	V
I <sub>R</sub>	reverse current	$V_R = V_{RRM}$ $T_{VJ} = 25^{\circ}C$ $T_{VJ} = 175^{\circ}C$		35 65	200 400	μA μA
V <sub>F</sub>	forward voltage	$I_F = 10 \text{ A}$ $T_{VJ} = 25^{\circ}\text{C}$ $I_F = 20 \text{ A}$		1.5	1.8	V V
		$I_F = 10 \text{ A}$ $T_{VJ} = 175^{\circ}\text{C}$ $I_F = 20 \text{ A}$		2.2	3.0	V V
I <sub>FAV</sub>	average forward current	$T_{C} = 80^{\circ}C$ rectangular, $d = 0.5$ $T_{C} = 100^{\circ}C$ $T_{VJ} = 175^{\circ}C$			25 22	A A
I <sub>F25</sub> I <sub>F80</sub> I <sub>F100</sub>	forward current	based on typ. $V_{F0}$ and $r_F$ $ T_C = 25^{\circ}C $ $ T_C = 80^{\circ}C $ $ T_C = 100^{\circ}C $			44 34 30	A A A
I <sub>FSM</sub>	max forward surge current	$t = 10$ ms,half sine (50 Hz) $T_{VJ} = 25^{\circ}C$ $T_{P} = 10 \mu s$ , pulse $T_{P} = 0$			1150	A A
V <sub>F0</sub>	threshold voltage	$T_{VJ} = 125^{\circ}C$		0.80		V
r <sub>F</sub>	slope resistance	for power loss calculation $T_{VJ} = 125^{\circ}C$ $175^{\circ}C$		0.73 57.0 70.5		$\begin{array}{c} {\sf V} \\ {\sf m}\Omega \\ {\sf m}\Omega \end{array}$
Q <sub>c</sub>	total capacitive charge	$V_R = 800 \text{ V}, I_F = 20 \text{A}$ $T_{VJ} = 25 ^{\circ} \text{C}$ $dI/dt = 200 \text{ A}/\mu \text{s}$		100		nC
С	total capacitance	$ \begin{array}{c} V_{\text{R}} = 0 \; V \\ V_{\text{R}} = 400 \; V \\ V_{\text{R}} = 800 \; V \end{array} \right\} \hspace{0.5cm} T_{\text{VJ}} = 25 ^{\circ} \text{C, f} = 1 \; \text{MHz} $		1500 93 67		pF pF pF
$R_{thJC}$ $R_{thJH}$	thermal resistance junction to case thermal resistance junction to heatsink	with heatsink compound; IXYS test setup		1.05	0.9	K/W K/W

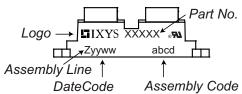




Package	Outlines SOT-227B (minibloc)		Ratings				
Symbol	Definitions	Conditions		min.	typ.	max.	Unit
I <sub>RMS</sub>	RMS current	per terminal				100	Α
T <sub>stg</sub> T <sub>op</sub> T <sub>VJ</sub>	storage temperature operation temperature virtual junction temperature			-40 -40 -40		150 150 175	°C °C °C
Weight					30		g
M <sub>D</sub>	mounting torque 1)		screws to heatsink terminal connection screws			1.5 1.3	Nm Nm
d <sub>Spp</sub>	creepage distance on surface		terminal to terminal terminal to backside	10.5 8.5			mm mm
d <sub>App</sub>	striking distance through air		terminal to terminal terminal to backside	3.2 6.8			mm mm
V <sub>ISOL</sub>	isolation voltage	t = 1 second t = 1 minute	50 / 60 Hz, RMS; $I_{ISOL} \le 1 \text{ mA}$	3000 2500			V
C <sub>P</sub>	coupling capacity per switch	between shorted to	erminals of diodes and back side metal-				pF

<sup>1)</sup> further information see application note IXAN0073 on www.ixys.com/TechnicalSupport/appnotes.aspx (General / Isolation, Mounting, Soldering, Cooling)





#### Part description

D = Diode

C = SiC

G = SIC
G = Extreme fast
45 = Current Rating [A]
X = Parallel legs
1200 = Reverse Voltage [V]
NA = SOT-227 (minibloc)

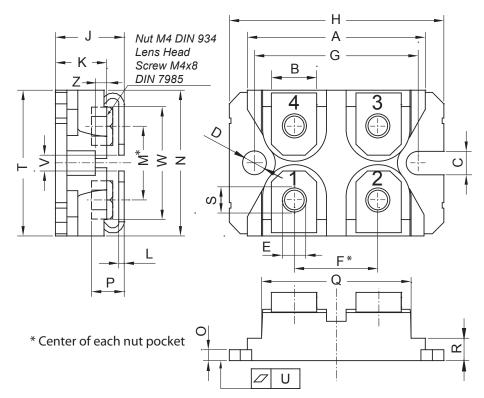
Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	DCG45X1200NA	DCG45X1200NA	Tube	10	520708

Equival	ent Circuits for Simulation	*on die level, typical			
$I \rightarrow V_0$	⊢_R <sub>o</sub> _⊢	T <sub>vJ</sub> = 125°C	T <sub>vJ</sub> = 175°C		
V <sub>0 max</sub>	threshold voltage	0.80	0.73	٧	
$R_{0  max}$	slope resistance *	57.0	70.5	mΩ	

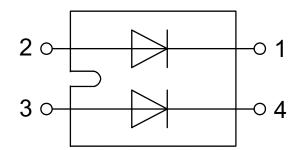




### **Outlines SOT-227B (minibloc)**



Dim.	Millimeter		Inches			
יוווט.	min	max	min	max		
Α	31.50	31.88	1.240	1.255		
В	7.80	8.20	0.307	0.323		
O	4.09	4.29	0.161	0.169		
D	4.09	4.29	0.161	0.169		
Е	4.09	4.29	0.161	0.169		
F	14.91	15.11	0.587	0.595		
G	30.12	30.30	1.186	1.193		
Н	37.80	38.23	1.488	1.505		
J	11.68	12.22	0.460	0.481		
K	8.92	9.60	0.351	0.378		
L	0.74	0.84	0.029	0.033		
М	12.50	13.10	0.492	0.516		
Ν	25.15	25.42	0.990	1.001		
0	1.95	2.13	0.077	0.084		
Р	4.95	6.20	0.195	0.244		
Q	26.54	26.90	1.045	1.059		
R	3.94	4.42	0.155	0.167		
S	4.55	4.85	0.179	0.191		
Т	24.59	25.25	0.968	0.994		
U	-0.05	0.10	-0.002	0.004		
V	3.20	5.50	0.126	0.217		
W	19.81	21.08	0.780	0.830		
Ζ	2.50	2.70	0.098	0.106		



## SiC Diode (per leg)

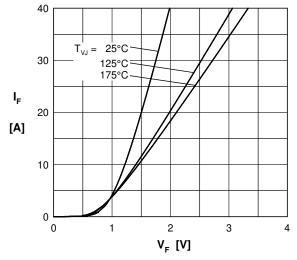


Fig. 1 Typ. forward characteristics.

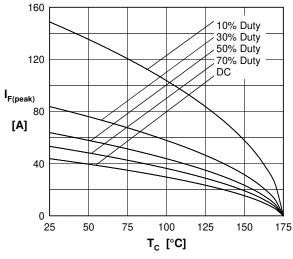


Fig. 3 Typ. current derating

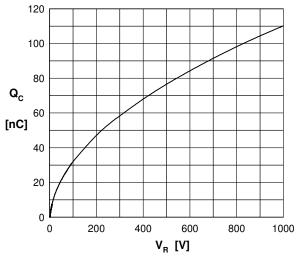


Fig. 5 Typ. recovery charge vs. reverse voltage

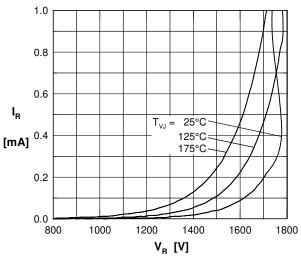


Fig. 2 Typ. reverse characteristics

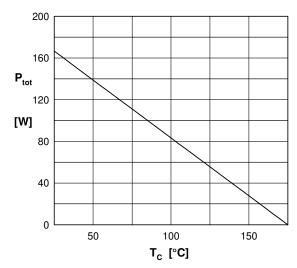


Fig. 4 Power derating

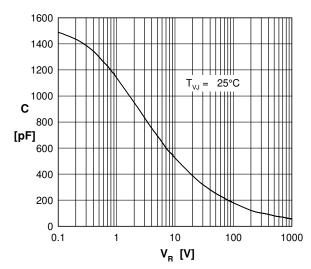


Fig. 6 Typ. junction capacitance vs. reverse Voltage

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### SiC Diode (per leg)

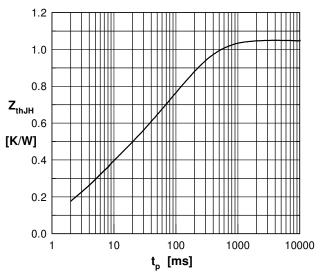


Fig. 7 Typ. transient thermal impedance